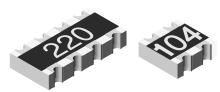
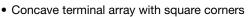


# Thick Film Chip Resistor Array



CRA06P thick film resistor array is constructed on a high grade ceramic body with concave terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts and assembly costs.

#### **FEATURES**







• Wide ohmic range: 10R to 1M0

• AEC-Q200 qualified

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$							
		0.063	50	100	1	10 to 1M	24 + 96	
CRA06P	03	0.003	30	200	2; 5	TO LO TIVI	24	
		Zero-Ohm-Resisto	or: $R_{\text{max.}} = 50 \text{ m}\Omega$ , $I_{\text{max.}} = 10 \text{ m}\Omega$	= 1 A				

TECHNICAL SPECIFICATIONS						
PARAMETER	UNIT	CRA06P 03 CIRCUIT				
Rated dissipation at 70 °C (2)	W per element	0.063				
Limiting element voltage (1)	V≅	50				
Insulation voltage (1 min)	V <sub>DC/AC</sub> peak	100				
Category temperature range	°C	-55 to +155				
Insulation resistance	Ω	> 10 <sup>9</sup>				

#### **Notes**

(1) Rated voltage: √P x R

<sup>(2)</sup> The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded

			printed should be and (another resistance). The rated dissipation applies only if the permitted limit competition of roce of is not exceeded							
PART NUMBER AND PRODUCT DESCRIPTION										
Part Number:	Part Number: CRA06P08347K0JTA (1)									
C R A 0 6 P 0 8 3 4 7 K 0 J T A										
		(Fee		<u>ا</u> لــــــــ						
MODEL	TERMINAL STYLE	F	PIN	CIRC	CUIT	VALUE	TOLERANCE	PACKAGING	(2) SPECIAL	
CRA06	Р		04	3 =	03	R = decimal	<b>F</b> = ± 1 %	TA	Up to 2 digits	
		(	80			K = thousand	$G = \pm 2 \%$	TC		
						$\mathbf{M} = \text{million}$ $0000 = 0 \Omega \text{ jumpe}$	$\mathbf{J} = \pm 5 \%$	or		
Broduct Door										
	rintion: CDAN6D	0 00	12 472	I DT1	~3					
	ription: CRA06P	08 0			e3	470			1	
CRA06P	ription: CRA06P	08 0	03 473		e3	473	J	RT1	e3	
				3		473	J TOLERANCE	RT1 PACKAGING (4)	e3 LEAD (Pb)-FREE	
CRA06P	08		0	T TYPE	RESI	STANCE VALUE 473 = 47 kΩ 1702 = 47 kΩ	F = ± 1 % G = ± 2 %			
CRA06P MODEL	08 TERMINAL CO		CIRCUI	T TYPE	RESI	  STANCE VALUE     <b>473</b> = 47 kΩ	<b>F</b> = ± 1 %	PACKAGING <sup>(4)</sup>	LEAD (Pb)-FREE  e3 = pure tin	

#### Notes

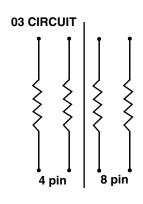
(1) Preferred way for ordering products is by use of the PART NUMBER

(2) Please refer to the table PACKAGING, see next page

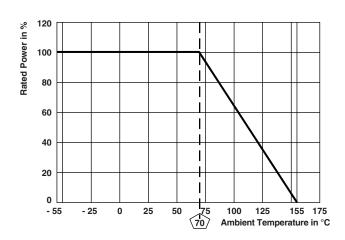


PACKAGING								
	KAGING CODE							
MODEL	TAPE WIDTH	DIAMETER	PITCH	PIECES/REEL	PAPER TAPE			
					PART NUMBER	PRODUCT DESCRIPTION		
CRA06P	8 mm	180 mm/7"	4 mm	5000	TA	RT1		
CRA06P 8 mm	330 mm/13"	4 mm	20 000	TC	RT6			

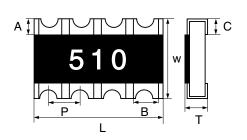
### **CIRCUIT**



## **DERATING**



## **DIMENSIONS**



			1
c b			w
<del> </del>	-   	a	<u> </u>

PIN	DIMENSIONS in millimeters								
NO#	L	Α	В	С	P	Т	W		
4	1.60	0.30	0.40	0.40	0.80	0.60	1.60		
8	3.20	0.30	0.40	0.40	0.80	0.60	1.60		
Tol.	± 0.20	± 0.20	± 0.15	± 0.20	-	± 0.10	± 0.15		

SOLDER PAD DIMENSIONS in millimeters								
	c w p a b							
WAVE	0.8	2.6	0.8	0.4	0.9			



TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1							
TEST	CONDITIONS OF TEST	REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R/R$ ) (1)					
(clause)	CONDITIONS OF TEST	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER				
	Stability for product types:	10 Ω to 1 MΩ	10 Ω to 1 MΩ				
	CRA06P	10 32 to 1 14132					
Resistance (4.5)	-	± 1 %	± 2 %; ± 5 %				
Temperature coefficient (4.8.4.2)	(20 / -55 / 20) °C and (20 / 125 / 20) °C	± 100 ppm/K	± 200 ppm/K				
Overload (4.13)	$U = 2.5 \times (P_{70} \times R)^{1/2}$ $\leq 2 \times U_{\text{max.}}; 0.5 \text{ s}$	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
Solderability (4.17.5) (2)	Aging 4 h at 155 °C, dryheat Solder bath method; 235 °C; 2 s Visual examination	<b>5</b> \	95 % covered) e damage				
Resistance to soldering heat (4.18.2)	Solder bath method; $(260 \pm 5)$ °C; $(10 \pm 1)$ s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)				
Rapid change of temperature (4.19)	30 min at LCT = -55 °C; 30 min at UCT = 125 °C; 5 cycles	± (0.25 % R + 0.05 Ω)	$\pm (0.5 \% R + 0.05 \Omega)$				
Damp heat, steady state (4.24)	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Climatic sequence (4.23)	16 h at UCT = 125 °C; 1 cycle at 55 °C; 2 h at LCT = -55 °C; 1 h/1 kPa at 15 °C to 35 °C; 5 cycles at 55 °C $U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$ ; whichever is less severe	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Endurance at 70 °C (4.25.1)	$U = (P_{70} \times R)^{1/2}$ $U = U_{\text{max.}}$ ; whichever is less severe 1.5 h "ON"; 0.5 h "OFF"; 70 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				
Extended endurance (4.25.1.8)	Duration extended to 8000 h	± (2 % R + 0.1 Ω)	± (4 % R + 0.1 Ω)				
Endurance at upper category temperature (4.25.3)	UCT = 125 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)				

#### Notes

# **APPLICABLE SPECIFICATIONS**

EN 60115-1 Generic specification
 EN 140400 Sectional specification
 EN 140401-802 Detail specification

• IEC 60068-2-X Variety of environmental test procedures

• EIA 481 Packaging of SMD components

<sup>(1)</sup> Figures are given for a single element

<sup>(2)</sup> Solderability is specified for 2 years after production or requalification. Permitted storage time is 20 years



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